Fall-2020 UM-SJTU JI Ve311 Lab #1

Instructor: Dr. Chang-Ching Tu

Due: 11:59 am, October 23, 2020 (Friday)

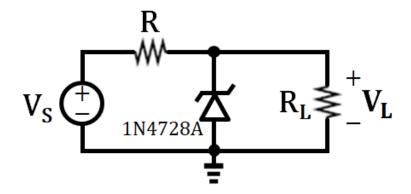
Note:

(1) Please use A4 size papers.

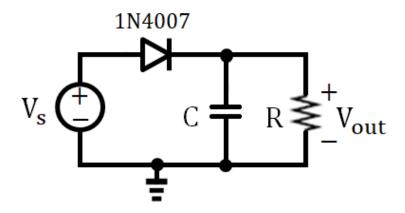
(2) The lab report should be submitted online individually.

(3) Use Proteus 8.10 for simulation before the lab session. In the Proteus library, you should be able to find all the components used in the schematics. The lab report must include both the simulation and measurement results.

- 1. [Voltage Regulator] Build the voltage regulator below in Proteus and on the breadboard.
 - (a) [10%] For $V_s = 10$ V, R = 5 k Ω and $R_L = \infty$, use a voltage meter to obtain the value of V_L . **Discussion:** Whether the obtained V_L is reasonable, in comparison to the V_Z in the 1N4728A datasheet?
 - (b) [20%] For $V_s=10+1sin(2\pi60\cdot time)$, $R=5\,k\Omega$ and $R_L=\infty$, display both V_s and V_L on oscilloscope. Estimate the line regulation by comparing the amplitudes of V_s and V_L . By using the equation: line regulation = $R_Z/(R+R_Z)$, estimate the value of R_Z . **Discussion:** If $V_s=2+3sin(2\pi60\cdot time)$, how will V_L change?
 - (c) [20%] For $V_s = 10$ V and R = 5 k Ω , by gradually decreasing R_L , find out the minimum R ($R_{L,min}$), below which the voltage regulator stops working. **Discussion:** How to modify the voltage regulator so that $R_{L,min}$ becomes 10 times smaller?



- 2. [Half-Wave Rectifier] Build the half-wave rectifier circuit below in Proteus and on the breadboard.
 - (a) [50%] For $V_s = 3 sin(2\pi 60 \cdot time)$ and $R = 10 \, k\Omega$, find out the value of C so that the ripple voltage (V_r) is smaller than 0.1 V. Display V_{out} on oscilloscope to confirm V_r is indeed smaller than 0.1 V, and estimate V_{dc} , I_{dc} , θ_c , ΔT , I_{peak} , I_{surge} and PIV based on the waveforms. Make sure the half-wave rectifier is reliable, that is I_{peak} , I_{surge} and PIV lower than the maximum ratings from the 1N4007 datasheet. **Discussion:** How will V_r change, if $V_s = 3 sin(2\pi 30 \cdot time)$?





Vishay Semiconductors

Zener Diodes



FEATURES

- Silicon planar power Zener diodes
- For use in stabilizing and clipping circuits with high power rating



- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN

FREE

DESIGN SUPPORT TOOLS AVAILABLE



PRIMARY CHARACTERISTICS					
PARAMETER	UNIT				
V _Z range nom.	3.3 to 100	V			
Test current I _{ZT}	2.5 to 76	mA			
V _Z specification	ecification Thermal equilibrium				
Circuit configuration	Single				

APPLICATIONS

Voltage stabilization

ORDERING INFORMATION						
DEVICE NAME	ORDERING CODE	TAPED UNITS PER REEL	MINIMUM ORDER QUANTITY			
1N4728A to 1N4764A	1N4728A to 1N4764A -series-TR	5000 per 13" reel	25 000/box			
1N4728A to 1N4764A	1N4728A to 1N4764A-series-TAP	5000 per ammopack (52 mm tape)	25 000/box			

PACKAGE							
PACKAGE NAME	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS			
DO-41 (DO-204AL)	310 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C			

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Power dissipation	Valid provided that leads at a distance of 4 mm from case are kept at ambient temperature	P _{tot}	1300	mW			
Zener current		Iz	P _V /V _Z	mA			
Thermal resistance junction to ambient air	Valid provided that leads at a distance of 4 mm from case are kept at ambient temperature	R _{thJA}	110	K/W			
Junction temperature		Tj	175	°C			
Storage temperature range		T _{stg}	-65 to +175	°C			
Forward voltage (max.)	I _F = 200 mA	V _F	1.2	V			



Vishay Semiconductors

ELECTRICA	AL CHARACTERIS	TICS (T _{amb} =	25 °C, un	less othe	rwise spec	ified)		
DART	ZENER VOLTAGE RANGE (1)		ST RENT	_	LEAKAGE RENT	DYNA RESIST f = 1	TANCE	SURGE CURRENT (3)	REGULATOR CURRENT (2)
PART NUMBER	V _Z at I _{ZT1}	I _{ZT1}	I _{ZT2}	I _R a	t V _R	Z _{ZT} at I _{ZT1}	Z _{ZK} at I _{ZT2}	I _R	I _{ZM}
	V	mA	mA	μA	V	2		mA	mA
	NOM.			MAX.		TYP.	MAX.		MAX.
1N4728A	3.3	76	1	100	1	10	400	1380	276
1N4729A	3.6	69	1	100	1	10	400	1260	252
1N4730A	3.9	64	1	50	1	9	400	1190	234
1N4731A	4.3	58	1	10	1	9	400	1070	217
1N4732A	4.7	53	1	10	1	8	500	970	193
1N4733A	5.1	49	1	10	1	7	550	890	178
1N4734A	5.6	45	1	10	2	5	600	810	162
1N4735A	6.2	41	1	10	3	2	700	730	146
1N4736A	6.8	37	1	10	4	3.5	700	660	133
1N4737A	7.5	34	0.5	10	5	4	700	605	121
1N4738A	8.2	31	0.5	10	6	4.5	700	550	110
1N4739A	9.1	28	0.5	10	7	5	700	500	100
1N4740A	10	25	0.25	10	7.6	7	700	454	91
1N4741A	11	23	0.25	5	8.4	8	700	414	83
1N4742A	12	21	0.25	5	9.1	9	700	380	76
1N4743A	13	19	0.25	5	9.9	10	700	344	69
1N4744A	15	17	0.25	5	11.4	14	700	304	61
1N4745A	16	15.5	0.25	5	12.2	16	700	285	57
1N4746A	18	14	0.25	5	13.7	20	750	250	50
1N4747A	20	12.5	0.25	5	15.2	22	750	225	45
1N4748A	22	11.5	0.25	5	16.7	23	750	205	41
1N4749A	24	10.5	0.25	5	18.2	25	750	190	38
1N4750A	27	9.5	0.25	5	20.6	35	750	170	34
1N4751A	30	8.5	0.25	5	22.8	40	1000	150	30
1N4752A	33	7.5	0.25	5	25.1	45	1000	135	27
1N4753A	36	7	0.25	5	27.4	50	1000	125	25
1N4754A	39	6.5	0.25	5	29.7	60	1000	115	23
1N4755A	43	6	0.25	5	32.7	70	1500	110	22
1N4756A	47	5.5	0.25	5	35.8	80	1500	95	19
1N4757A	51	5	0.25	5	38.8	95	1500	90	18
1N4758A	56	4.5	0.25	5	42.6	110	2000	80	16
1N4759A	62	4	0.25	5	47.1	125	2000	70	14
1N4760A	68	3.7	0.25	5	51.7	150	2000	65	13
1N4761A	75	3.3	0.25	5	56	175	2000	60	12
1N4762A	82	3	0.25	5	62.2	200	3000	55	11
1N4763A	91	2.8	0.25	5	69.2	250	3000	50	10
1N4764A	100	2.5	0.25	5	76	350	3000	45	9

Notes

⁽¹⁾ Based on DC measurement at thermal equilibrium while maintaining the lead temperature (T_L) at 30 °C + 1 °C, 9.5 mm (3/8") from the diode body

⁽²⁾ Valid provided that electrodes at a distance of 4 mm from case are kept at ambient temperature

 $^{^{(3)}}$ $t_p = 10 \text{ ms.}$

Vishay Semiconductors

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

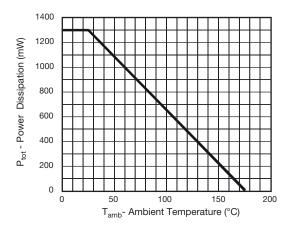
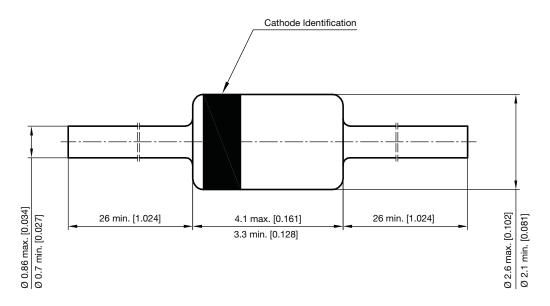


Fig. 1 - Admissible Power Dissipation vs. Ambient Temperature $P_{tot} = f(T_{amb})$

PACKAGE DIMENSIONS in millimeters (inches): DO-41 (DO-204AL)_1N47xx



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Vishay

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Axial-Lead Glass Passivated Standard Recovery Rectifiers

This data sheet provides information on subminiature size, axial lead mounted rectifiers for general-purpose low-power applications.

Features

- Shipped in Plastic Bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Available in Fan-Fold Packaging, 3000 per box, by adding a "FF" suffix to the part number
- Pb-Free Packages are Available

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds, 1/16 in. from case
- Polarity: Cathode Indicated by Polarity Band



ON Semiconductor®

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LEAD MOUNTED RECTIFIERS 50-1000 VOLTS DIFFUSED JUNCTION



CASE 59-10 AXIAL LEAD PLASTIC

MARKING DIAGRAM



A = Assembly Location 1N400x = Device Number x = 1, 2, 3, 4, 5, 6 or 7

YY = Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

Rating	Symbol	1N4001	1N4002	1N4003	1N4004	1N4005	1N4006	1N4007	Unit
†Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
†Non-Repetitive Peak Reverse Voltage (halfwave, single phase, 60 Hz)	V _{RSM}	60	120	240	480	720	1000	1200	V
†RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
†Average Rectified Forward Current (single phase, resistive load, 60 Hz, T _A = 75°C)	lo	1.0				Α			
†Non-Repetitive Peak Surge Current (surge applied at rated load conditions)	I _{FSM}	30 (for 1 cycle)				Α			
Operating and Storage Junction Temperature Range	T _J T _{stg}			-	-65 to +17	5			°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. †Indicates JEDEC Registered Data

THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Maximum Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	Note 1	°C/W

ELECTRICAL CHARACTERISTICS†

Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage Drop, (i _F = 1.0 Amp, T _J = 25°C)	v _F	0.93	1.1	V
Maximum Full-Cycle Average Forward Voltage Drop, (I _O = 1.0 Amp, T _L = 75°C, 1 inch leads)	$V_{F(AV)}$	-	0.8	V
Maximum Reverse Current (rated DC voltage) $ (T_J = 25^{\circ}C) $ $ (T_J = 100^{\circ}C) $	I _R	0.05 1.0	10 50	μΑ
Maximum Full-Cycle Average Reverse Current, (I _O = 1.0 Amp, T _L = 75°C, 1 inch leads)	I _{R(AV)}	-	30	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. †Indicates JEDEC Registered Data

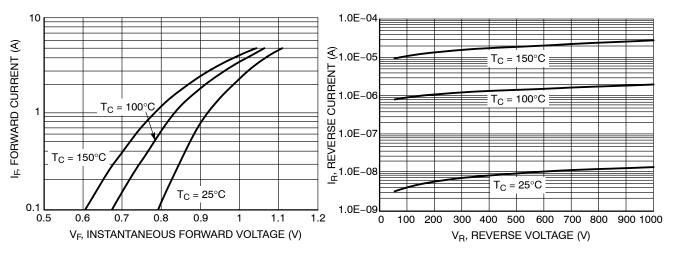


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

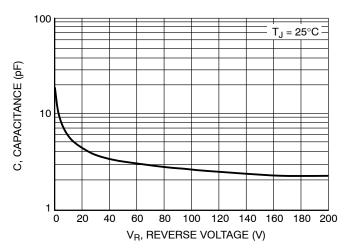


Figure 3. Typical Capacitance

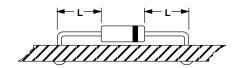
NOTE 1. – AMBIENT MOUNTING DATA

Data shown for thermal resistance, junction–to–ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

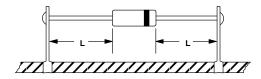
TYPICAL VALUES FOR $\textbf{R}_{\theta \text{JA}}$ IN STILL AIR

Mounting		Lea			
Metho	d	1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\theta JA}$	67	80	87	°C/W
3			50		°C/W

MOUNTING METHOD 1

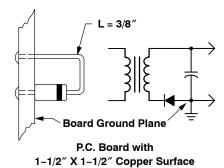


MOUNTING METHOD 2



Vector Pin Mounting

MOUNTING METHOD 3



ORDERING INFORMATION

Device	Package	Shipping [†]
1N4001	Axial Lead*	1000 Units/Bag
1N4001G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4001FF	Axial Lead*	3000 Units/Box
1N4001FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4001RL	Axial Lead*	5000/Tape & Reel
1N4001RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel
1N4002	Axial Lead*	1000 Units/Bag
1N4002G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4002FF	Axial Lead*	3000 Units/Box
1N4002FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4002RL	Axial Lead*	5000/Tape & Reel
1N4002RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel
1N4003	Axial Lead*	1000 Units/Bag
1N4003G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4003FF	Axial Lead*	3000 Units/Box
1N4003FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4003RL	Axial Lead*	5000/Tape & Reel
1N4003RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel
1N4004	Axial Lead*	1000 Units/Bag
1N4004G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4004FF	Axial Lead*	3000 Units/Box
1N4004FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4004RL	Axial Lead*	5000/Tape & Reel
1N4004RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel
1N4005	Axial Lead*	1000 Units/Bag
1N4005G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4005FF	Axial Lead*	3000 Units/Box
1N4005FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4005RL	Axial Lead*	5000/Tape & Reel
1N4005RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *This package is inherently Pb-Free.

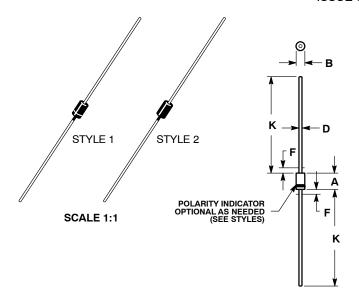
ORDERING INFORMATION

Device	Package	Shipping [†]
1N4006	Axial Lead*	1000 Units/Bag
1N4006G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4006FF	Axial Lead*	3000 Units/Box
1N4006FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4006RL	Axial Lead*	5000/Tape & Reel
1N4006RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel
1N4007	Axial Lead*	1000 Units/Bag
1N4007G	Axial Lead* (Pb-Free)	1000 Units/Bag
1N4007FF	Axial Lead*	3000 Units/Box
1N4007FFG	Axial Lead* (Pb-Free)	3000 Units/Box
1N4007RL	Axial Lead*	5000/Tape & Reel
1N4007RLG	Axial Lead* (Pb-Free)	5000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*This package is inherently Pb-Free.

AXIAL LEAD CASE 59-10 **ISSUE U**

DATE 15 FEB 2005



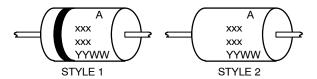
STYLE 1: PIN 1. CATHODE (POLARITY BAND) STYLE 2: NO POLARITY

2. ANODE

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- CONTROLLING DIMENSION: INCH. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY POLARITY DENOTED BY CATHODE BAND. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.161	0.205	4.10	5.20	
В	0.079	0.106	2.00	2.70	
D	0.028	0.034	0.71	0.86	
F		0.050		1.27	
K	1.000		25.40		

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code = Assembly Location Α

YY = Year WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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1N4007FFG 1N4007G 1N4007RL 1N4007RLG